

# TECHNICAL DATASHEET



# Brazing alloy BrazeTec Soldamoll 230 C TD EN SLDM230C REV. 0

### **Composition (% in weight)**

Ag	Cu	Zn	Sn	Si	Р	Mn	Ni	Other	ISO 17672:20 10	EN 1044:1999	ISO 3677
-	3	-	Res t	-	-	-	-	-	-	-	-

### **Technical data:**

Melting range (°C)	230 - 250
Working temperature (°C)	-
Melting range according to DSC measurement (°C)	-
Min. brazing temperature (°C)	-
Electrical conductibility (m/ $\Omega$ mm <sup>2</sup> )	7,5
Elongation %	-
Density (g/cm³)	7,3
Shear strength (MPa)	-
Tensile strength DIN EN 12797 (MPa)	Cu: 30 ; Brass: 20 ; S235: 25
Operating temperature of brazed joint (min/max) $\pm$ (°C)	-

## **Applications**

Plumbing technology, electrical industry

#### **Operating conditions**

Tin based brazing alloy, free from antimony and lead. Excellent flow, capillarity and mechanical strength characteristics. Used for joining steel, copper and copper alloys, as well as nickel and nickel alloys. Suitable for copper pipes installations for plumbing system.

#### **Recommended fluxes**

Core alloy with colophony flux.

#### **Heat sources**

Flame, induction heating, resistance

#### **Delivery forms**

Core wire, core rods, core rings

#### **Notes**

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